# High Voltage DC-DC Converter 

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# High Voltage DC-DC Converter Project \#SJB 2A06 

A Major Qualifying Project submitted to the faculty of
Worcester Polytechnic Institute
in partial fulfillment of the requirements for the
Degree of Bachelor of Science

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## 1 Abstract

This project involved the design of a high-voltage DC-DC converter capable of converting 12 VDC into 170 VDC and delivering 250 W of power. The design is based on a push-pull topology utilizing power MOSFET switches, a custom center-tapped transformer, and an allanalog feedback control system. The design comprised the front-end of a DC-AC sinewave inverter and was implemented using a custom PCB and tested. The control circuitry worked as expected, however the power-side switching posed several issues that remain to be resolved.

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## 2 Introduction

AC inverters are a common device in today's society. They are often used to take a low voltage DC source, such as the battery in a motor vehicle, and supply a 120 volt ac source running at 60 Hz . Since the market for such a product is so large, many competitors have entered with various implementations. Cheap designs use a "modified sine wave" which looks like a square wave. Although this is able to power devices which need the 120 volts, substantial amounts of noise are introduced into the circuits. This introduced noise is highly undesirable with audio devices. To avoid this problem, a true sine wave must be generated from the DC source. Such products exist in the market, but have a high cost associated with them. In an attempt to lower costs, a method of generating a pure sine wave with Pulse Width Modulation is being implemented. One stipulation to using Pulse width modulation is the assumption that the source voltage be larger than the output voltage. This introduces a need for a DC-DC converter which can provide the inverter with a high voltage source. Because the desired output of the inverter is 120 volts RMS, the DC-DC converter must supply 170 volts consistently.

## 3 Product Requirements

In order for the DC-DC converter to be integrated into the AC inverter, the design must meet the following requirements.

### 3.1170 volt output

The output voltage should be 170 volts in order to accommodate the input to the DC-AC inverter. The source should be able to stay constant with a varying load. If the voltage does drop due to a large change in load, the recovery time of the supply should not interfere with the inverter's operation.

### 3.2 High efficiency

Since the Dc-Dc converter is only $1 / 2$ of the final product, the efficiency must be high in order for the final product to be economical. However minor improvements in efficiency should not be substituted for greatly increased price. This would take away from the purpose of the design.

### 3.3 The output power should be larger than 250 watts.

The converter should be able to handle loads in excess of 250 watts. Since the goal of the inverter is to provide a load with 250 watts of useable power, the converter must be designed to handle a larger power load. It must be able to compensate for the losses of power within itself, along with the power losses in the DC-AC step.

## 4 Current Method of Implementation

There are many methods of making a DC-DC converter. For this project, most of them were ruled out because the output was not isolated from the input or they did not operate in the necessary power range. This section takes into consideration the three topologies that were seriously considered and the controls circuit that will be used for implementation of this project.

A generic block diagram of how one of these converters works with feedback loop can be seen in Figure 1.

## GENERIC ISOLATED DC-DC CONVERTER



Figure 1: Block diagram of generic DC-DC converter
From this block diagram it is easy to see that the switches control the current that gets fed into the transformer. From there, the transformer creates a magnetic field which induces a voltage on the secondary side of the transformer. This voltage then turns on a part of the rectifying circuit and charges a capacitor. From there the signal is passed through an LC filter to remove ripples, forming the output of the DC converter. The output is continuously monitored by the switching controller to adjust the duty cycle of the switches. This feedback loop is normally isolated through optical or magnetic means when using an isolated topology.

### 4.1 Half Bridge Topology

The half bridge converter has eighty percent efficiency at five hundred watts of power. It also has a fifty percent duty cycle and isolates the input from the output through a two winding transformer.

For the half bridge converter, shown in Figure $2^{1}$, when switch Q1 is on, current flows through the top half of the primary side of T 1 , expanding the magnetic field in T 1 . The expanding magnetic field induces a voltage across T 1 secondary, such that diode D 2 is forward biased and diode D1 is reverse biased. D2 conducts and charges capacitor C3 via L1.

When Q1 turns off, the magnetic field in T1 collapses and after a period of dead time, Q2 switches on. Current flows through the bottom half of the transformer and the magnetic field in T1 expands. The direction of the magnetic flux is opposite that of Q1, so now D1 is forward biased and D2 is reverse biased. D1 conducts and charges C3 via L1. After a period of dead time, Q1 conducts and the cycle repeats.


It is very important that Q1 and Q2 are not turned on at the same time. If they were, they would short circuit the supply. Therefore the conduction time of each transistor must not exceed half of the total period for one complete cycle.

It is also important to make sure the magnetic behavior is uniform; otherwise the transformer will saturate and destroy Q 1 and Q 2 . This requires that the individual conduction times of Q1 and Q2 be exactly equal. For a larger picture of the half bridge schematic, please reference Appendix A: Half Bridge.

[^0]
### 4.1.1 Waveforms

The waveforms for the half bridge converter can be seen in Figure $3^{2} . \mathrm{V}_{\mathrm{GS}}(\mathrm{Q} 1)$ is the voltage from the gate terminal to the source terminal of the switch $\mathrm{Q} 1 . \mathrm{V}_{\mathrm{DS}}(\mathrm{Q} 1)$ is the voltage from the drain terminal to the source terminal of the switch $\mathrm{Q} 1 . \mathrm{V}_{\mathrm{SW} 2}$ is another view of the voltages of the switch. $\mathrm{I}_{\mathrm{SW} 2}$ is the current through the switch which also flows through the primary winding of the transformer.


Figure 3: Waveforms for half bridge topology
For a larger picture of the half bridge waveforms please reference Appendix A: Half Bridge.

[^1]
### 4.1.2 Pros/Cons

## Pros

- Transformer design is not critical


## Cons

- Unstable voltage from capacitors on primary side
- Switching losses


### 4.2 Full Bridge Topology

The full bridge converter has eighty-five percent efficiency at one thousand watts of power. It also has a fifty percent duty cycle and isolates the input from the output through a two winding transformer.

The full bridge converter, shown in Figure $4^{3}$, is very similar to that of the half bridge converter. Instead of Q1 in the half bridge, the full bridge has Q1 and Q4 on at the same time and Q2 and Q3 on instead of Q2. There is no floating source in the full bridge design (caused by the capacitors C1 and C2 in the half bridge design). Instead of the diodes charging capacitor C3, they charge capacitor C 2 . Other than that, this circuit works the exact same way as the half bridge.


Figure 4: Schematic for full bridge topology
The same warnings about conduction time and magnetic behavior also exist for the full bridge. For a larger picture of the full bridge schematic, please reference Appendix B: Full Bridge.

[^2]
### 4.2.1 Waveforms

The waveforms for the full bridge converter can be seen in Figure $5^{4} . \mathrm{V}_{\mathrm{GS}}(\mathrm{Q} 1 \& \mathrm{Q} 4)$ is the voltage from the gate terminal to the source terminal of the switches $\mathrm{Q} 1 \& \mathrm{Q} 4 . \mathrm{V}_{\mathrm{DS}}(\mathrm{Q} 1 \& \mathrm{Q} 4)$ is the voltage from the drain terminal to the source terminal of the switches $\mathrm{Q} 1 \& \mathrm{Q} 4 . \mathrm{V}_{\mathrm{SW} 2}$ is another view of the voltages of the switch. $\mathrm{I}_{\mathrm{SW} 2}$ is the current through the switch which also flows through the primary winding of the transformer.


Figure 5: Waveforms for full bridge topology

For a larger picture of the full bridge waveforms, please reference Appendix B: Full Bridge.

### 4.2.2 Pros/Cons

## Pros

- Most efficient type of converter
- Handles high power applications


## Cons

- Higher efficiency at higher power
- Highest switching losses

[^3]
### 4.3 Push Pull Topology

The push pull converter has eighty-five percent efficiency at three hundred fifty watts of power. It also has a fifty percent duty cycle and isolates the input from the output through a three winding transformer.

The push pull converter, shown in Figure $6^{5}$, works similar to that of the half bridge converter.


Figure 6: Schematic for push pull topology
The same warnings about conduction time and magnetic behavior also exist for the full bridge. Due to the fact that the push pull converter implements a three winding transformer, it must also satisfy the condition that the two halves of the centre-tapped transformer primary be magnetically identical. For a larger picture of the push pull schematic, please reference Appendix C: Push Pull.

### 4.3.1 Waveforms

The waveforms for the half bridge converter can be seen in Figure $7^{6} . \mathrm{V}_{\mathrm{GS}}(\mathrm{Q} 1)$ is the voltage from the gate terminal to the source terminal of the switch $\mathrm{Q} 1 . \mathrm{V}_{\mathrm{DS}}(\mathrm{Q} 1)$ is the voltage from the drain terminal to the source terminal of the switch $\mathrm{Q} 1 . \mathrm{V}_{\mathrm{SW} 2}$ is another view of the voltages of the switch. $\mathrm{I}_{\mathrm{SW} 2}$ is the current through the switch which also flows through the primary winding of the transformer.

[^4]

Figure 7: Waveforms for push pull topology
For a larger picture of the push pull waveforms, please reference Appendix C: Push Pull.

### 4.3.2 Pros/Cons

## Pros

- Frequently preferred in desired power range
- Simple Switching


## Cons

- Switches require higher voltage rating
- Voltage spikes


### 4.4 Controls

As with any product where the output is desired to be at a certain level, there must be a way of comparing the actual output with the desired output. This control will have to isolate the output from the input, but still be able to give feedback. For the feedback loop, an opto-isolator will be used. This will provide optical or magnetic isolation from the output to the input. The actual control circuit will be specified in the next part of the project. Figure 8 is the flowchart of one possible implementation of controlling the output voltage using Pulse Width Modulation, PWM.

Voltage Control With PWM


Figure 8: Flowchart of control scheme

## 5 Proposed Implementation

It took some research and analysis of what is important to this project to decide on a topology to use.

### 5.1 Value Analysis Chart

To compare all the different topologies and all the criteria that are important in a dc-to-dc converter, a value analysis chart was chosen. The chart itself is displayed in Appendix D: Value Analysis Chart. The result of the chart was to use a full bridge topology because it was the most efficient topology, albeit most complicated as well.

### 5.2 Chosen Topology

According to the value analysis chart, the topology to use is the full bridge. However, after more research it was found that the full bridge only attained high efficiency at high power ratings. For what this project needs, the push pull is a more realistic choice.

The push pull topology is isolated just like the full bridge, has high efficiency in the desired power range and is relatively simple to design.

### 5.3 Specifications

As a result of the research into different methods and current implementations of DC-DC switching supplies, broad specifications have been determined, these can be seen in Table 1. The purpose for the specifications are to steer the direction of further investigation and experimentation of the proposed design. The following chart contains the proposed specs

Table 1: Proposed specifications

| Proposed specifications |  |
| :---: | :---: |
| Topology: |  |
| Eush Pull |  |
| Efficiency: |  |
| Controls: |  |
| Ripple: |  |
| Isolated voltage feedback |  |
| Power output: |  |
| Cooling: |  |
| Passive |  |

Below is a brief description as to the why each specification has been chosen.

### 5.3.1 Push pull topology

The push pull topology is an ideal choice for this Dc-Dc converter for multiple reasons. The most important reason is the isolation between the source and output provided by the magnetics in the transformer. Another deciding factor is the simplicity of the switching over a full bridge design. By only having to turn on 1 switch at a time, timing issues become less critical. The other important factor is that the push pull topology is commonly used at this power level. This makes the research on the topology more reliable and achievable.

### 5.3.2 85 \% efficient

Even though the push pull topology has been documented to have efficiencies, above $90 \%$, they are for very specialized designs and are using high end components. Within consumer goods they can be purchased with efficiencies around $80 \%$, which is common. Based on this background knowledge, an efficiency of $85 \%$ seems a reasonable goal in the allotted time.

### 5.3.3 Passive cooling

With the desire to reduce complexity of the design and improve efficiency, the DC-DC supply should be designed with passive cooling. Although the amount of heat produced will be substantial from the $\mathrm{I}^{2} \mathrm{R}$ losses in the primary winding, proper layout of the components should suffice for temperature considerations of the components.

### 5.3.4 Less than 2\% ripple

A ripple of no greater than $2 \%$ of the output voltage should be observed from the supply. The reason behind establishing the maximum ripple is to ensure minimal noise is introduced into the system during the DC-AC stage. It is likely though this arbitrary value of an acceptable ripple will change based on the needs of the inverter.

### 5.3.5 Isolated feedback control

A feedback control scheme will be used to actively regulate the output voltage. By changing the duty cycle of the switches on the primary side of the transformer, based on the controls, the voltage will stay constant as current is increased to the output. The feedback loop will be isolated either optically or magnetically, to ensure complete isolation of the input and output.

## 6 Market Research

When starting a new project, before even thinking about the design, the first thing that should be done is market research. Market research can save a lot of time and money, both of which are precious commodities.

According to Norman T. Brust, founder of NTB Associates, a client of his spent months worth of time and over twenty-thousand dollars of his own money to develop a device to blow the meat out of the claw of a small crab. Since whole crab claw meat is worth more than partial crab claw meat, his client wanted to sell this device to fisheries to help them maximize the amount of crab meat they get from the claws. After talking with Mr. Brust, the client only had to wait approximately twenty-four hours before getting a result.

The result was that there was a world-wide customer base of two companies, both in the U.S. Both of these companies hired the wives of the fishermen to extract the meat from the claw. They were uninterested in this new device. Even though it would improve profits, it would harm employees and their families.

The client then decided to modify the device for a different type of crab, but his wife refused to let him proceed. He had already spent too much time and money. Had he started out with doing market research, he would not have wasted so many resources.

With this project, the first thing that was done was market research. What was found was that, yes there are high voltage DC-to-DC converters, but they are about $85 \%$ efficient and are costly, upwards of one hundred dollars. The purpose of this project is to at the very least maintain, and at best improve efficiency while driving down the cost.

Based on market research, there is a need for a $12 \mathrm{vdc}-\mathrm{to}-170 \mathrm{vdc}$ converter. It is just a matter of making it efficient and affordable. Competing devices are too expensive or not efficient enough.

## 7 Proposed Implementation Challenges

As nice as it would be to have a design without flaws or any kind of problems leading up to the actual manufacturing of the device, that is unrealistic. Every product that is designed runs into problems, whether expected or unexpected. Some expected challenges of this project are as follows:

- Determining optimum switching frequency
- Minimizing transformer losses
- Sufficiently protecting driver switches without reducing efficiency
- Integrating feedback loop to switching controller
- Accurately simulating transformer and switches within converter

One of the major challenges will be accurately simulating the design prior to the testing. If the design can be modeled, then steps to optimize various components can be taken prior to assembly and testing. The challenge in modeling this design is in the magnetics and switches. Losses which are based on frequency, material constants of the core, and coupling will all need to be taken into consideration if estimations in efficiency are to be believed. As for the switching, timing as losses on the junctions and parasitic capacitances due to the high frequency will need to be accounted for.

Another challenge is the integration of the feedback loop into the switching controller. When the load increases, the controller will need to sense the difference in real time and make adjustments within the next time step within the circuit. Due to the high frequencies the methods used to adjust the switches will be handled in an analog manner.

The sooner potential problems are identified, the sooner measures can be taken to make sure they don't arise, or if it is inevitable, to minimize the effect of the problem. There is nothing worse than running into an unexpected problem, and then having to stop all other aspects of research to deal with that problem.

## 8 Research Conclusion

After doing much research, it was found that there is a need for a 12 vdc to 170 vdc converter as part of an AC inverter. It was also shown that for the power range of 250 W , the best topology to use is the push pull converter because it gets $85 \%$ efficiency at 350 W whereas the half bridge and full bridge operate at 500 W and 1000 W respectively.

## 9 Design

Shown in Figure 9 is the schematic for the implementation of converting 12 VDC to 170 VDC. Basically how this circuit works is that the 12VDC battery is connected to two N-MOS transistors which are being used as switches. Each transistor will be on at different times to induce a current through the transformer. If the transistors are on at the same time, they will short circuit the supply and saturate the transformer. The transformer has a $1: 14$ turns ratio so the 12 VDC on the primary side of the transformer becomes 168 VDC on the secondary side.
The two diodes on the secondary side of the transformer create a full wave rectifier. In order to protect the diodes from voltage spikes, each diode is placed in parallel with an RC snubber circuit. At this point, the voltage is passed through an LC filter. This filter acts as a low-pass filter allowing only signals with frequencies lower than the cut-off frequency through, while blocking all others. After going through the filter, the voltage is then scaled down to a 5 V scale using resistor R4.


Figure 9: Push pull schematic
At this point in the overview of the circuit, it is important to go over the control scheme shown in Figure 10. The scaled down voltage is connected to an opto-isolator to isolate the power part of the circuit from the control part. Now that the voltage is isolated, it is compared to a 5VDC source through a differential amplifier. As the name suggests, this device amplifies the difference
between the two signals. This amplified "error" signal is then used as input to another op-amp which is being used to bias the error signal. This biased error signal is then compared to a triangular waveform using a third op-amp. This op-amp compares the triangle waveform with the DC bias from the previous op-amp to adjust the duty cycle of the MOSFET switches. Connecting the duty cycle to the switches is gate driver for the switches. The gate driver allows the MOSFETs to change state as quickly as possible and also prevents both MOSFETs from being turned on at the same time.


Figure 10: Control loop schematic

Currently, the control loop is in the process of being revised. The reason for this is because there are too many op-amps in the feedback circuit doing minor adjustments to the signal at each step. With a few more calculations and simulations, the circuit will be able to be reduced to one opamp comparing the scaled down Vout with VRef, then biasing it with VBias, and then filtering before being fed into the op-amp for the duty cycle. Essentially, the new design will make the opamp for VControl obsolete since the operations being done there will be done in the op-amp for VError.

### 9.1 Switching

The push pull topology relies on two switches to cycle current through the transformer at high frequencies. There are two types of switches which can be used within the design; MOSFETs (Metal Oxide Silicon Field Effect Transistors) or BJT's (Bi-Polar Junction Transistors). In each case the transistor would be running in saturation mode when turned on. This enables the transistors to resemble the characteristics of an ideal switch. There is however with both transistors, a resistance present when in saturation mode. The resistance causes energy to be wasted as heat within the device. Since the goal of this design is to be highly efficient, the on resistance of transistor should be minimal. A model of one of the switches can be seen in Figure 11.

Another important factor in choosing the transistor is the speed at which the device is capable of switching. The transistor must be able to switch states from on to off quickly for two reasons. The first is so that it can switch at the operating frequency. In this push pull design, the operating frequency is 50 kHz . However, with a push pull design, each transistor must be able to operate at twice the frequency. This is because each switch must be open for some duty cycle of one half of the operating frequency. During the second half of the cycle, the transistor is off, allowing the magnetic flux in the core to reset. The second reason the switching speed is important with the transistor, is the energy dissipation. When a switch is transitioning from off to on, it is in a linear region, which has a high resistance. Since the current can not reduce due to the inductance of the transformer, power (current squared multiplied by the resistance of the device) is being wasted. With a faster switching time, less energy can be wasted, thus improving the efficiency of the design.


Figure 11: Schematic of switch with zener diode protection

The maximum voltage the transistor can accommodate should also be considered when choosing the device. This voltage should be larger than the voltage source which will be across the switch. To protect from Voltage spikes, an additional zener diode should be placed across each switch.

Based on the described parameters, a MOSFET which has a very low on resistance is the best choice. The maximum voltage the MOSFET should be able to handle needs to surpass 12 volts DC. The MOSFET should be N-MOS because it does not need a larger voltage than the source to bias it on. N-MOS should also be used because it typically performs at faster speeds than P-MOS and will reduce switching losses.

### 9.2 Transformer

When examining the design of a transformer, shown in Figure 12, there are a few key parameters which need to be chosen before the design of the transformer can be done. These parameters are based on the general formula ${ }^{7}$, Equation 1.0 which governs how a push pull topology will behave which is as follows


Figure 12: Schematic of transformer

$$
\begin{equation*}
V_{\text {out }}=2 \cdot \frac{N_{2}}{N_{1}} \cdot D \cdot V_{\text {in }} \tag{Eq.1.0}
\end{equation*}
$$

The first is input and output voltages. This design specifies 12 volts dc will be applied as the input, and about 170 volts dc will be the output. The other parameter which must be chosen is at what duty cycle of the switches should this voltage be obtained. In order for our design to have room to accommodate for losses within the system, a duty cycle of 0.5 was chosen. Based on these choices we can determine a turns ratio of the transformer. Unfortunately the turns ratio solved for

[^5]does not equal an integer. However if we reduce the expected output voltage to 168 volts, a turns ratio of 28 works perfectly. Having an output voltage of 168 volts is not an issue because it is assuming $50 \%$ duty cycle. Once the duty cycle is increased to 0.5059 , the output becomes the 170 volts.

Transformers used in push-pull designs normally have multiple windings. In this design there will be 4 windings, two primary and two secondary windings. The primary windings will be $1 / 28^{\text {th }}$ the amount of turns as the secondary windings. Each set of windings will be attached together so that the transformer behaves like one transformer with a center tap on the primary and secondary side.

Next the core dimensions and material were chosen from the Magnetics Company catalog. The core needed to be large enough to allow large wires to be wound due to the average dc input current being 20 amps . The core also needed to be large enough to not saturate the flux during peak use. As for the material of the core, it should be designed for high frequency and have very low losses, especially since the transformer is hand wound. The core chosen is from Magnetics' MMP line which is designed to have the lowest losses. This makes the core more expensive compared to similar cores. The core achieves low losses at the frequency being operated because it is a powder core. Ferrite powder is epoxied together. This insulation of the particles almost completely eliminates eddy currents in the core.

The particular part is the MMP 55906. The important parameters of this core include the inner diameter which is 1.9 inches, the permeability of the core, $\mu_{\mathrm{r}}$ which is 125 , the mean length of the core, 0.1995 m and the cross sectional area of 0.0227 m .

### 9.2.1 Using the formula

To determine how many times each wire should be wrapped around the core, the delta change in the input current needs to be chosen, see Equation 2.0. This value determines the approximate inductance L of the core for the first winding.

$$
\begin{align*}
\Delta I_{\text {in }}= & \frac{V_{\text {in }}}{L_{\text {core }}} \cdot 0.5 \cdot \frac{t}{2}  \tag{Eq.2.0}\\
& 2=\frac{12}{L_{\text {core }}} \cdot 0.5 \cdot \frac{20 \times 10^{-6}}{2} \longrightarrow L_{\text {core }}=30 \mathrm{uH}
\end{align*}
$$

Now with L approximated for the design, the calculations of the number of turns needed can be done, Equation 3.0.

$$
\begin{align*}
& N_{1}=\sqrt{\frac{\text { Length }_{\text {core }} \cdot L_{\text {core }}}{U_{0} \cdot U_{r} \cdot \text { Area }_{\text {core }}}}  \tag{Eq.3.0}\\
& N_{1}=\sqrt{\frac{0.1995 \cdot 30 \times 10^{-6}}{125 \cdot 4 \cdot \pi \cdot 10^{-7} \cdot 0.0227}}=1.29 \longrightarrow 2 \text { turns }
\end{align*}
$$

Once N1 is determined, N2 can be determined

$$
N_{2}=28 \cdot N_{1}=56 \text { turns }
$$

Since N2 was rounded up to 2, the inductance of the winding has changed as follows

$$
2=\sqrt{\frac{0.1995 \cdot L_{\text {core }}}{125 \cdot 4 \cdot \pi \cdot 10^{-7} \cdot 0.0227}} \longrightarrow L_{\text {core }}=71.5 u \mathrm{H}
$$

With the inductance change, the delta of the current in also changed as follows

$$
\Delta I_{\text {new }}=\frac{12}{71.5 \times 10^{-6}} \cdot 0.5 \cdot \frac{20 \times 10^{-6}}{2} \longrightarrow \Delta I_{\text {new }}=0.839 \mathrm{~A}
$$

Based on these calculations the core will perform well and have plenty of space for the two sets of the 2 turns of the primary and 56 turns of the secondary winding.

### 9.3 Rectifier

The two diodes in this circuit form a full bridge rectifier. Diode D8 on the top of the


Figure 13: Schematic of rectifier diode with RC snubber protection
schematic, shown in Figure 13, is turned on when switch M1 is turned on. Diode D8 on the bottom of the schematic is turned on when switch M2 is turned on. The diodes are never on at the same time because the switches are never on at the same time. To protect the diodes an RC snubber
circuit is connected in parallel with each diode. The way the snubber circuit works is that it suppresses electrical transients by limiting the rate of rise in the voltage. Without the snubber in place, there is a chance of a voltage spike across the diodes which would permanently damage the diodes.

### 9.4 Filter

The combination of the inductor L1 and capacitor C3 create an LC second order low-pass filter, shown in Figure 14. The low-pass filter allows only signals with frequencies lower than the cut-off frequency to pass through, while blocking others. For this circuit, the cut-off frequency is 25165 Hz (158116 rad). Ideally the low-pass filter has a flat pass band - no gain and no attenuation - and completely attenuates all other frequencies. However, an ideal filter is not possible and after the cut-off frequency, the pass band will be falling off at the rate of $-40 \mathrm{~dB} / \mathrm{Dec}$.


Figure 14: Schematic of LC Filter

### 9.5 Isolation

In order to keep the output voltage at 170 VDC , it is necessary to control the amount of time the switches are turned on. The first step in this process is to scale down and isolate the output voltage. The output voltage of 170 VDC needs to be scaled down to a 5 VDC scale. To do this, a large R, shown in Figure 15, is necessary. The most common way of implementing an isolator is by using an LED and a light sensor. When the LED turns on, the light sensor activates and detects the amount of light being emitted and produces a current that is proportional to the amount of light.


Figure 15: Schematic of resistor for scaling

### 9.6 Differential Amplifier

The differential amplifier, shown in Figure 16, takes two inputs and amplifies the difference between the two signals as its output. At this point in the control scheme, the scaled down output


Figure 16: Schematic of differential amplifier
voltage is compared with the 5VDC reference voltage. The difference between the two inputs is then amplified by a constant determined by the resistors. The scaled Vout is attached to the Vterminal and the reference voltage is attached to the $\mathrm{V}+$ terminal. When the voltages are exactly the same, there will be no output from this device. However, when the two voltages are different the difference between them is used as input to the Vcontrol part of the control circuit.

### 9.7 Voltage control

The voltage control loop, shown in Figure 17, sets a biased low voltage level based on feedback from the 170 volt output from the converter. This voltage is used to determine the necessary duty cycle for maintaining a constant output. The voltage control circuit has 4 steps. First the output must be reduced to a scaled low voltage through isolation. The purpose of the isolation is to protect the ICs from damage which could come from a high voltage spike. The scaling and isolation is accomplished with a resister and a current fed optical isolation IC. The amount of current into the component is proportional to the voltage at the output and thus makes


Figure 17: Schematic of V_Control
a proportional voltage on the output of the IC. Next a reference voltage is subtracted from the input. This value represents the delta which the voltage must change to reach the desired value. At this point in the circuit, a gain is applied to the error. The purpose of this amplification is to make the returned signal correct the delta quickly. If the gain is too low, the time required to reduce the error to 0 will be too long. However if the gain is increased too high, the control loop is liable to become unstable with large spikes in the error correction and have uncontrollable oscillations. After the error is amplified, a biased voltage is added to the signal. This v bias sets what the duty cycle should be when the error is 0 for the switches. A schematic of the implementation of these steps is attached.

### 9.8 Duty cycle control

The duty cycles of the switches are determined based on the output voltage of the converter. As the voltage drops below the desired value, the duty cycle is increased to supply more power


Figure 18: Schematic of duty cycle controller
through the transformer. Once the voltage reaches and begins to exceed the correct output voltage, the duty cycle of the switches is reduced to hold the value. The input in to this control circuit, shown in Figure 18, is the control voltage and a triangle wave which is running at the operating frequency of 50 kHz . The triangle wave is generated using an a-stable multivibrator out of some opamps, resistors and a capacitor. Both signals, the triangle and control, are attached to a comparator. The triangle is attached to the V - terminal and the control is attached to the $\mathrm{V}+$ terminal. The $\mathrm{V}+$ rail for the comparator is set to the necessary voltage to saturate the MOSFET switches. When the control voltage is less than the triangle, the duty cycle is 0 and the MOSFETs will not turn on. As the control voltage increases, a larger proportion of the triangle wave becomes less than the control, turning the comparator high along with the MOSFETs longer. Once the control voltage is larger than the triangle waves, the duty cycle is $100 \%$. For the push pull design however, the duty cycle must be kept below $100 \%$ so the core of the transformer can reset.

### 9.9 Switching driver

The purpose of the switching driver, shown in Figure 19, is to make the MOSFET change states as quickly as possible. The input to the driver circuit is the PWM pulses which represent the duty cycle that the MOSFET will operate at. The voltage of the input pulses will be based on the


Figure 19: Schematic of switching driver
requirements of the MOSFET's requirements. Most MOSFETs which would be used in this design would only need a gate voltage of between 3.6 to 6 volts. One of the important requirements for the switching driver is the ability to introduce a delay into the signal. The reason is that there will be one PWM signal being produced from the control loop and one of the two switches must react exactly at $\mathrm{T} / 2$ where T is the duration of time for one cycle. Although the task of having the two signals could be approached earlier in the control loop, adding a time delay to the signal as it goes into one of the switches ensures better matching of the duty cycle to each switch. It is because of this desire for a time delay, that a MOSFET driver IC is appropriate to be used. The IC's output will attach directly to the MOSFET switch's gate. The IC will be designed to drive N-MOS MOSFETs and will not require bootstrapping to raise the gate voltage. The IC will also have a low power consumption, to improve efficiency of the design.

## 10 Simulations

To gain an understanding of how this circuit is going to work, a simulation was made using Pspice in conjunction with OrCad Capture. The purpose of the simulation was to examine how the current flowed through the system, specifically through the diodes, and filter. Simplifications were made in the simulation for the switches. As a substitute for the MOSFETs a voltage controlled switch was implemented in the simulation with a series resistance equaling the Rds-on value from the datasheet for the MOSFET planned on being used. Certain non-linear characteristics, i.e. hysterisis and saturation of the core, of the transformer could not be modeled because Pspice is a linear simulation tool. As a simplifying assumption in the model the transformer was made to be ideal with a coupling constant of 0.99 . In the simulation the load was represented by a 200 Ohm resistor which

### 10.1 Results

The results of the simulation we were able to produce multiple waveform graphs which helped us understand the characteristics of some of the components. All graphs that were found to be relevant in determining parameters are in the following sections. The most notable parameters were:

- Expected power losses from the MOSFETs
- Break-down voltage of the rectifier diodes
- Average forward current through the diodes
- Snubber circuit
- L and C filter values


### 10.1.1 Expected Power Losses from the MOSFETs

The calculated power loss in each of the MOSFETs, when on, was determined by examining the current multiplied by the Rds-on multiplied by the duty cycle. A graph of this can be seen in Figure 20. To ensure the value graphed was realistic a quick calculation of $\mathrm{P}=I^{2}$ Rds-on*duty cycle equals

$$
P=20^{2} \cdot 0.0038 \cdot 0.5=0.76
$$

This value is reasonably close to the value in the simulation so we can conclude the simulation should have accurate data.


Figure 20: Power loss in MOSFET

### 10.1.2 Diode Break-down Voltage

The diode break-down voltages were simulated with a real diode STTH5L06 which is an ultra-fast high voltage rectifier. There were extremely large voltage spikes and a snubber circuit was added to remove the voltage spikes. During the initial start-up of the circuit, the diode experiences a voltage spike around 440 V as shown in Figure 21. Once the circuit reached a steady state the voltage stayed around 400 V as shown in Figure 22.


Figure 21: Transient of voltage across diodes


Figure 22: Steady state diode voltage

### 10.1.3 Average Forward Current through the Diodes

The forward current through the diodes was simulated with a real diode STTH5L06 which is an ultra-fast high voltage rectifier. During the initial start-up of the circuit, the diode experiences a current spike around 2.1A as shown in Figure 23. Once the circuit reached a steady state the current stayed around 1.45A as shown in Figure 24.


Figure 23: Transient of current through diode


Figure 24: Steady state current through diode

### 10.1.4 Snubber Circuit

The need for a snubber circuit was realized when high voltage spikes were seen across the diode. The purpose of the snubber circuit is to remove the high frequency spikes by having the capacitor collect the charge and then discharge through the resistor. Through multiple simulations, it was found that the values of $\mathrm{C}=5 \mathrm{nF}$ and $\mathrm{R}=1 \mathrm{k} \Omega$ minimized the amount of voltage spiking across the diodes.

### 10.1.5 L and C Filter Values

The values for the LC filter were determined by using the formula

$$
\Delta V=\frac{(1-2 \cdot[\text { DutyCycle }]) \cdot \text { Vout }}{32 \cdot F^{2} \cdot L \cdot C}
$$

Choosing $\mathrm{L}=20 \mu \mathrm{H}$ and $\mathrm{C}=2 \mu \mathrm{~F}$ the Vout is a smooth line after 4 ms . This represents a very low $\Delta \mathrm{V}$ therefore the LC values will accomplish the goal of $2 \%$ ripple according to the simulation.


Figure 25: LC Filter

## Design Conclusion

Based on these schematics and simulations, the circuit will work. A triangle wave generator will be assembled so the circuit will not require the use of a function generator. The only problem that remains is how to ensure only one MOSFET is on at any given time.

## 11 Block Diagram

A generic block diagram is good to have when starting the design of a project, but once you're ready to actually start implementing the design and building the device, it is even better to have a specific block diagram. Just like having a very detailed outline makes writing a paper easy, a very detailed block diagram makes drawing a schematic using a schematic capture software program very easy.

When this project was started, a generic block diagram was used to describe how the device was going to be designed, this can be seen in Figure 1, and for ease of comparison can also be seen here in Figure 26. Since then, most of the blocks haven't changed, but more specific information has been added to show how the device will work, this specific block diagram is shown in Figure 27.

The Optical/Magnetic Isolation block in the original block diagram was removed from the specific block diagram and the Feedback block was broken down into blocks pertaining to the specific tasks of the control scheme (these changes will be explained later in this report). If you were to take the specific block diagram and hold it next to the schematic, you would be able to see where each of the blocks is implemented.

GENERIC ISOLATED DC-DC CONVERTER


Figure 26: Generic block diagram of DC-DC converter

One other change in the block diagram is the use of arrows of different widths. The thicker arrows in Figure 27 show the flow of energy through the device, while the thinner arrows show the control circuitry. This distinction was not made in Figure 26.


Figure 27: Specific block diagram of high voltage DC-DC converter

## 12 Revisions to Design before Prototype

As mentioned before changes were made to the block diagram, which led to changes in the schematic, and ultimately the prototype. Some of the changes were to take out parts that were not going to be implemented others were to add in parts that were to be implemented.

### 12.1 Isolation

Based on the original block diagram, a device was to be used to provide optical/magnetic isolation. In the final implementation of this device, that component was not used. It was not from lack of finding a device to do this, to the contrary there were plenty of devices that would isolate the output from the controls the problem was with not fully understanding how the component works and how it would affect the functionality of the device. Instead of using an opto-isolator to isolate the output from the controls and give a proportional voltage to the control side, a very common and non-isolated technique was used to test the controls. A voltage divider was used to obtain a voltage of 4.4 V when the output is 170 V .

### 12.2 New Control Design

The original control design, shown in Figure 10 and here in Figure 28 was very simplistic compared to what it evolved to when the prototype was being designed, shown in Figure 29. The original control circuit used a function generator to create a triangle wave and


Figure 28: Original control schematic


Figure 29: Control circuit used for prototype
was using a lot of resistors and operational amplifiers each doing one task that was simplified in just a couple resistors and op-amps doing the same tasks. The seven resistors associated with U 2 and U3 and U2 and U3 themselves were simplified to one op-amp and nine resistors. A Schmidt Trigger was used to produce a square wave running at 55 k Hz , the output of which is then used as the input for an integrator, generating as an output a triangle wave. This self-sustaining circuit means the function generator initially used to create the triangle wave will no longer be necessary and changes to other parts of the circuit will not affect the triangle wave generator.

To obtain a 5 volt reference for the differential amplifier, a 5 volt regulator was used. This component takes as its input, the 12 volts from the battery and outputs a constant 5 volts. The difference between this voltage and the scaled down output is then amplified by a factor of ten, and ideally gives as an output 6 volts. This DC voltage is then compared with the triangle wave generator giving as an output a PWM. With an output voltage of 170 volts, the output of the comparator should have a $50 \%$ duty cycle and automatically adjust to a less than $50 \%$ duty cycle if
the output is greater than 170 volts and greater than a $50 \%$ duty cycle if the output is less than 170 volts.

Only one MOSFET can be turned on at one time, otherwise the core of the transformer is at risk for saturation. To prevent both MOSFETs from being turned on at the same time, a frequency divider had to be implemented. The last step of the control circuit is to take the output of the square wave and use it as input to a frequency divider. Both the inverting and non-inverting output of the frequency divider is ANDed with the PWM output. The output of each of the AND gates is used as input for one of the gate drivers. This configuration ensures that only one MOSFET will be turned on at a time.

### 12.3 Inductor

An inductor of the order of $20 \mu \mathrm{H}$ was used in the initial design of the output LC filter. However, this inductor is not capable of handling the current on the output side of the transformer. In order to handle the current, the $20 \mu \mathrm{H}$ needed to be replaced by a 6.8 mH inductor. Just changing the inductor would change the resonant frequency, which can be found by using Eq. 4.0, of the LC filter. The frequency of the control circuitry is 55 k Hz , the frequency of the filter should be a factor of ten greater or smaller than that. To make the LC filter have a resonant frequency of 5 k Hz , Eq. 4.0 needs to be solved for C , yielding Eq. 4.1. Using this equation a 150 nF capacitor is needed.

$$
\begin{align*}
& f_{0}=\frac{1}{2 \pi \sqrt{L C}}  \tag{Eq.4.0}\\
& C=\frac{1}{\left(2 \pi f_{0}\right)^{2} L} \tag{Eq.4.1}
\end{align*}
$$

## 13 Transformer Building

The design and building of the transformer is an integral part of the entire DC-DC converter. Because the turns ratio required was not a standard design, and the fact that our current requirements were larger than most stocked transformers, it became apparent the transformer would need to be hand wound. However, determining how to safely handle 21 amps of current led to an approach which was more complicated than just 2 times around with 1 wire and 56 times around with a separate wire.

Based on the American Wire Gauge standard, a single wire of size 10 or larger would be needed to handle current spikes over 30 amps . The problem is when the wire is that thick, it does not conform well to the square shape it would be wrapped around, leading to a lower coupling with the core, and thus lower efficiency. To solve the problem, multiple sets of windings were attached in parallel. Besides enabling the wire to be thinner and thus wrap closer, it also allowed the current to be spread evenly throughout the core and leads to a better coupling between the primary and secondary side. In the final design, 3 sets of AWG 14 wire with a voltage insulation of 250 volts were used.

On the secondary side, since the current would only be around 1.5 amps , the wire did not need to be paralleled. In both cases the wire used was stranded copper since the switching frequency was not large enough to worry about losses from eddy currents. However if the design needed to be more efficient, litz wire should be used to replace the current implementation.

When assembled, the transformer has 12 turns of the primary, 6 sets of 2 m and 112 turns of the secondary, 2 sets of 56 . Each set of the secondary and 3 sets of the primary represent 1 side of the center tapped transformer, with an identical count for the other side. To create these nodes, the soldering of each of the wires was done directly to the board, eliminating the need for splicing wire connections. Since the inner diameter of the core chosen was large enough, only 2 layers of wires were needed. The secondary wires are closest to the core, with the larger, primary sets of wires being wrapped tightly around them. A photo of the completed transformer being attached to the PCB board can be seen Figure 30:


Figure 30: Hand wound core, 1:28 turns ratio

## 14 Part selection

When choosing parts to be used for the prototype, some general rules were followed to facilitate in the building stages. The most important was to use through hole components whenever possible. Through hole allows us to quickly assemble the prototype by hand and do not require special soldering equipment like some smaller surface mount forms. We also determined through hole components allow for quicker and neater reworking of the PCB. Wires can easily be tacked onto the bottom of the board to the pins. The only downside is through hole components would take up larger amounts of space and effect traces and layout on both layers of the board.

Another general rule followed for part selection was to avoid specialty components wherever possible. By using readily stocked components, our ability to replace any item damaged during testing becomes cheaper and significantly reduces downtime between tests. The TL082 opamp, along with the 74 series D-Flip-Flop and NAND gates were chosen for this reason.

Current carrying ability was also very important in the part selection, especially in the power side of the design. Based on the simulations and calculations of the current levels, the switching MOSFETs, rectifier diodes, and filter components were chosen to handle well above the anticipated current at full load. The MOSFETs for example are rated at 140 amps continuous, even though, they should have an average current of 21 amps . To see a full list of part numbers of the components used in the design, refer to Appendix E: Bill of Materials

## 15 PCB Layout

The PCB board was designed using Ultiboard layout software. The advantage of Ultiboard is because it interlinks with Mutlisim so well. Ultiboard allows the schematic to be imported and can actually check the connections between parts to ensure proper wiring. Unfortunately since our power and control design were completed separately and integrated as a last step, the wiring checks were not used at this stage. Since this board was designed to test the circuitry and not fit into a certain form factor. The dimensions chosen for the board were 10 inches by 6 inches. This allowed plenty of space to mount all the components directly to the board including the 3 inch diameter transformer. Also by having a large board, the layout could be done to intuitively understand the flow of energy in the circuit. The layout actually is very similar to the block diagram of the system. The 12 volts enters the circuit on the left, flowing through the switches, transformer and filter along the upper part of the board from left to right. Then from the 170 volt output on the right, the control circuitry flows right to left from the triangle wave generator, to the PWM, to the logic circuits and driver chips. To monitor the whole design, in the upper left side of the board, there are various test points in the circuit.

Since the board is large enough, only 2 layers for traces are needed to interconnect all the points. On the bottom layer, a ground plane is used to reduce noise and allow for larger currents to flow. However due to the size of some traces used, there are some signal wires which are also run through the bottom layer with vias. These traces were isolated by a 20 mil clearance on every side from the ground plane.

### 15.1 Power

Within the power side of the design, there are a couple of unique requirements which were implemented into the PCB. One of the most obvious features of the power side of the PCB is the trace widths used. When the converter is running at full load, approximately 21 amps of current will be flowing through the primary side of the circuit, the traces needed to be made as wide as possible. At some points the trace is as wide as 900 mils. One of the reasons for such wide traces was from limiting the trace thickness. Normally PCB manufactures offer multiple steps in thickness, starting at 1 oz copper, up to 3 and even 4 oz copper; 2 oz copper being twice as thick as loz. The downside to choosing a thicker copper is the significant increase in manufacturing cost, whereas in this situation, increasing the width did not affect the cost directly. The widths chosen for
the traces were calculated based on a trace width calculator. The formula implemented by the calculator is as follows:

$$
I=0.0647 \cdot d T^{0.4281} \cdot A^{0.6732} \text { for external traces }
$$

where:
$\mathrm{I}=$ maximum current in Amps
$\mathrm{dT}=$ temperature rise above ambient in ${ }^{\circ} \mathrm{C}$
$\mathrm{A}=$ cross-sectional area in mils ${ }^{2}$

Another result of having such large currents at the input side of the converter is the double banana jack terminals used. Each banana jack is capable of 15 amps continuous, so by adding the ability to connect 2 in parallel, the board would be capable of approximately 30 amps from the power source. Since the output should never have over 1.5 amps flowing, only one set of terminals was used.

The last part which makes the layout of our power side is the traces used with the transformer. 3 custom circles of approximately 600 mils wide were used as the footprint of the primary side. The secondary side was connected to the rectifier diodes with vias and 100 mil wide traces. The purpose of the 3 circles were to simplify the wiring of the transformer. Each circle represents a node; the outer circle is the center tap where the 12 volts is connected. Each of the other circles are connected to ground through the power MOSFETs. On the outer ring, there are 6 holes used to solder the parallel sets of windings, while the inner 2 circles have 3 each. These circles are on the bottom layer of the board and therefore are on the same plane as the ground plane. This reduces the chances of the board acting as a parallel plate capacitor within the large surface area.

### 15.2 Controls

The op-amps used in the control circuitry are TL082's. This is an eight pin DIP with two op-amps on each chip, and was chosen for this reason and because they have a very fast slew rate of 13 volts $/ \mu \mathrm{s}$. Each op-amp in the schematic corresponded to one TL082 on the board just incase an op-amp was blown; the other side of the chip could still be used, after some rewiring to obtain desired outputs.

In the PCB layout software, the controls were laid out in a fashion that allowed for grouping of components that worked closely with one another. The op-amps for the square wave and triangle
wave are right next to each other as are the ones for the DC bias voltage and the comparator. The frequency divider is near the PWM output, the benefit of this will be explained later in this paper. The AND gates are near the driver chips to minimize the possibility of a time delay causing both MOSFETs to be turned on at the same time.

## 16 Revisions to Prototype

While assembling and testing the completed printed circuit board a few mistakes were found in the design. Most of the mistakes were easily fixed by removing unnecessary components, cutting traces, changing where a wire goes, adding circuitry that was in the schematic but was accidentally left out of the PCB design. All the revisions to the control side can be seen at the end of this section in Figure 31. The revisions to the power side were just adding in components that were in the schematic, but were accidentally left out of the PCB design so there is no new schematic for that.

### 16.15 volt Regulator

During testing before the PCB was made, the 5 volt regulator was not giving 5 volts as an output; in fact, the output was not even in the specified range. To fix this problem on the breadboard, a second 5 volt regulator was added in parallel, doing this provided 5 volts on the output pin. While testing the PCB, it was found that only one regulator was needed because it was providing the expected 5 volt output; the second regulator in parallel was never soldered to the board.

### 16.2 Triangle Wave Generator

The integrator chip which should be producing a triangle wave for an output was not producing this output. While making the traces in Ultiboard, the traces to pins 5 and 6 of the integrator got swapped. To solve this problem, the traces leading to these pins were cut, and the proper wiring was made on the bottom of the board. With this change made, a triangle wave was produced at the output.

### 16.3DC Bias

During the design of the PCB four resistors were used to scale down the 170 volt output of the power side to 2.5 volts and provide a DC bias level of 1.9 volts. Now the same result, a voltage of 4.4 volts, is achieved using just two resistors.

### 16.4Differential Amplifier

The resistors on the differential amplifier were swapped out for resistors of higher resistance to reduce power losses. Increasing the value of the resistor in the filter means the value of the capacitor needs to be reduced to keep the same time constant.

### 16.5Frequency Divider

Initially, the input to the frequency divider was the square wave output. However, this was giving unexpected results at the output of the logic gates. What was happening was one driver would turn off, then immediately the other one would turn on, not giving the transformer time to reset itself. After trying to delay the signal from the frequency divider and not having much success, it was decided to change the input to the frequency divider. The input was changed from the square wave to the signal containing the PWM. This solved the issue of having one of the logic gates turn off and immediately having the other one turn on.

## 16.6(N)AND

On the PCB, two AND gates are being used to AND the PWM with the non-inverting output of the frequency divider on one gate, and with the inverting output on the other gate. Since the input of the frequency divider was changed the output of the AND gates no longer interfered with one another (no more sharp off of one and sharp on of the other). Now the problem was the MOSFET driver was changing the signal from the AND gate.

The low side of the driver is an inverter because of the Schmidt trigger in the driver chip. So it would invert the signal, when it is in a closed loop. It's only an issue when the PWM is not $50 \%$. To fix this, the output of the AND has to be inverted and easiest way is to use a NAND. The pins on the NAND are the exact same as the AND. The NAND gate also has a faster propagation delay.

### 16.7 Driver Chip

To make the driver chip work correctly, the high side MOSFET had to be faked. In order to do this a few changes had to be made. A capacitor had to be added to the bootstrap (pins 2 to 4). Pin 4, the low rail of the high side driver was then tied to ground through a resistor. A delay resistor was also added from Pin 5 to ground. With these changes, the driver was able to turn the MOSFET on and off.

Nelson
Ruscitti

### 16.8RC Snubber

The RC snubber circuitry used to protect the rectifying diodes was accidentally left out of the PCB design. These components were added across the diodes on the underside of the board.


Figure 31: Revised control schematic

## 17 Testing

After making the changes to the board, it was time to make sure the changes would work.
Here are explanations of the tests performed and the outcomes.

### 17.1 Controls

Testing the controls meant simulating a 170 volt output and observing the output waveforms of the triangle oscillator, the PWM, the frequency divider and the NAND gates, along with measuring the power used.

### 17.1.1 Output Waveforms

The output of the square wave integrator resulted in a triangle wave which was compared with a DC bias to produce a PWM; this wave form is shown in Figure 32. Ideally with a 170 volt output this PWM has a duty cycle of $50 \%$.


Figure 32: PWM created by triangle wave

The PWM signal is then used as input to the frequency divider. This will divide the frequency of the PWM by a factor of two, as can be seen in


Figure 33: PWM used in frequency divider
The NAND gates as inputs take the PWM and then either the inverting or non-inverting input of the frequency divider and produces the output shown in Figure 34. This signal is then used as input to the drivers which tell the MOSFETs when to turn on. Using this implementation also prevents the MOSFETs from being turned on at the same time.


Figure 34: NAND gate output

### 17.1.2 Control Side Current Draw

After discussing with a couple professors, it was found that the power consumed on the control side of the board was too high. The control side was drawing 1.12 W , at 12 volts means there was 93 mA of current. After some analysis, it was found that the D Flip-Flop and the NAND gate were drawing extra current because the unused sides of those IC's were tied to ground. When IC's have their unused inputs tied to ground they don't draw extra current, but when the unused outputs are tied to ground, they are going to draw more current. With this known, the unused outputs were removed from ground, but the unused inputs were left tied to ground. This significantly reduced the amount of current being drawn, and the power used as well. Now the control side is drawing 30 mA of current at 12 volts, meaning it uses 360 mW of power - that's more than a one-third reduction in the amount of power used!

### 17.2 Power testing

The testing of the power side was completed in two steps. The first stage was using a power supply to source the 12 volts input to the converter. The purpose of the power supply is to be able to limit the current entering the system. By limiting the current to a few amps, the likelihood of components overheating from a short circuit is reduced. The power supply also allowed for a precise input voltage. The second stage was to do a high current test. The source for this test was a 12 volt car battery. On the high current test, a high power load was also used to ensure power transfer through the circuit.

### 17.2.1 Current limited

To safely test and find any shorts in the circuit, a power supply was used by providing 12 volts and 2 amps . The fuse being used during this test had too high of a current rating - the traces on the board would melt before the fuse blew - so a light bulb was used in place of the fuse. This helped verify that the MOSFETs were switching accurately without burning them out. To remove noise on the gate of the MOSFET, a $330 \mu \mathrm{~F}$ capacitor (by-pass cap) was added across the power supply, a revised schematic of the power side can be seen in Figure 35.


Figure 35: Final power schematic
As expected, when the duty cycle was adjusted the output voltage changed proportionally. However, the proportional change was inversely proportional, which was not expected - they should be directly proportional to one another. The reason for this turned out to be the two pairs of wires on the transformer's secondary side were inverted on the board. The wires that were tied to ground were supposed to be connected to the diodes, and vice-versa. To fix this, the wires were un-
soldered, then re-soldered in the correct configuration. When this was done, the current through the transformer increased as the duty cycle increased, which is what was expected from simulations. To more accurately see what was happening at the output, the inductor of the LC filter was removed to minimize the amount of oscillation. With the inductor temporarily removed, voltage peaks were seen around 95 volts with a duty cycle of just $10 \%$ !

### 17.2.2 Full scale test

The high current test was done using a 12 volt car battery as the source, shown in Figure 36. To protect the circuitry, the first power up test was completed using a 5 amp fuse to the switching MOSFETs. When the current draw increased over 5 amps , the power would disconnect from the transformer, allowing the control loop to function normally. All testing at the high current level was done in pulses, so that the converter was not operating for more than a few seconds at a time to diagnose issues found. To control the PWM during the high current test, a power supply was used to set the biased point of the comparator instead of through the closed loop. As a load, a 100 volt, 40 watt light bulb was attached to the output.


Figure 36: Setting up the high power test

The first power up lasted approximately two seconds. Within that amount of time the 5 amp fuse melted. However the light bulb did become very bright for that duration. At this point it was determined to increase the fuse to 15 amps . When powered up again, the light bulb stayed lit and the fuse did not blow instantly. During the 15 amp test, the waveforms of the output and gate voltages were measured, shown in Figure 37. The correlation between when the gate turned on and ripple in the output was very noticeable. During this stage the output ripple was $\sim 50$ volts with a dc level of $\sim 125$ volts. The size of the ripple was due to the lack of inductor in the circuit for the testing.


Figure 37: Output of high power test
In order to see if the brightness, and therefore power output of the converter could be increased, the duty cycle of the PWM was increased to $\sim 40 \%$. At this point two major observations in the operation occurred. The RC snubber circuits were designed with a resister not capable of dissipating the amount of energy being fed into them. During the next power up, the resistors emitted smoke and then began to shoot blue sparks. The remains of the snubber circuit can be seen in Figure 38. The other observation was that only one of the two MOSFETs were switching. After
turning off the circuit and checking the driver circuit on the non functional MOSFET, no issues were found. This leads to the assumption that the MOSFET was damaged either by heat applied to the gate when re-soldering a joint, or some unpredicted interaction with the transformer's inductance.


Figure 38: RC snubber

## 18 Results

With all the re-work done to the board, Figure 39, an output was finally obtained!


Figure 39: PCB with revisions
As can be seen from the graphs in the testing section, the circuit is working. The controls are working perfectly and only have a power loss of 360 mW . The power side has some room for improvement. The switching MOSFETs are not working as expected. One of the two MOSFETs is turning on and off; the other would not turn on during high current testing, but worked afterwards during low current testing. The MOSFET that was switching was getting extremely hot, using an infrared temperature sensor, a temperature of over $180^{\circ} \mathrm{F}$ was recorded after short durations of testing. When working off one switching MOSFET, voltages around 120 volts with a ripple of approximately 50 volts were observed when tested without an inductor in the LC filter.

## 19 Design Conclusion

Changes were made to the design of the PCB both before and after it was received. Had all the necessary changes been caught before the board was sent out to be made, it would have saved a lot of time and frustration later on. The controls are working, but there are issues getting the MOSFETs to switch as expected during high current testing. Adjustments in the input voltage to the controls changes the duty cycle of the PWM as expected. The first time the transformer was turned on, there was smoke - a few components had to be replaced. After taking another look at the data sheets and revising the board a little an output was obtained, although it was just able to power a 40 W light bulb with a voltage of approximately 120 volts.

Nelson
Ruscitti

## 20 Costs

One question you might have at this point is if the device was fully operational and you had a sine wave inverter to attach to the 170 volt output, how much would the DC-DC converter cost? To answer your question, let's look at Figure 40. As you can see from this Bill of Materials, it will cost approximately $\$ 81$ just for the components to assemble this device, with the transformer consisting of about half the cost. The full Bill of Materials with vendor names and part numbers can be found in Appendix E: Bill of Materials. Please note that these prices are based on Digikey and ECE shop prices. Also note that all components ordered were in small quantities so there might be volume discounts that do not apply here.

| Quantity | Description | Price |
| :---: | :---: | :---: |
| 2 | RESISTOR, 1.0kOhm_5\% | \$ 0.10000 |
| 2 | CAPACITOR, 5.1nF | \$ 0.47200 |
| 1 | CAPACITOR, 1.0uF | \$ 0.25000 |
| 2 | ZENER, 02BZ2.2 | \$ 0.99000 |
| 2 | POWER_MOS_N, IRF530 | \$13.00000 |
| 1 | Transformer | \$39.76000 |
| 1 | INDUCTOR, 10mH | \$ 9.56000 |
| 2 | DIODE, 1N4151 | \$ 0.01050 |
| 1 | 50_AMP, 50_AMP | \$ 0.25000 |
| 1 | Banana Jack | \$ 7.93000 |
| 1 | RESISTOR, 1.0kOhm_5\% | \$ 0.10000 |
| 1 | RESISTOR, 10kOhm_5\% | \$ 0.10000 |
| 5 | RESISTOR, 20kOhm_5\% | \$ 0.10000 |
| 1 | CAPACITOR, 1.0nF | \$ 0.25000 |
| 1 | CAPACITOR, 10nF | \$ 0.25000 |
| 2 | CAP_ELECTROLIT, 100uF-POL | \$ 1.00000 |
| 1 | RESISTOR, 7.5kOhm_5\% | \$ 0.10000 |
| 2 | RESISTOR, 200kOhm_5\% | \$ 0.10000 |
| 1 | VOLTAGE_REGULATOR, LM7805CT | \$ 0.60000 |
| 4 | OPAMP, TL082CP | \$ 0.64000 |
| 2 | 74LS, 74LS08D | \$ 0.53000 |
| 1 | 74STD, 7474N | \$ 0.53000 |
| 2 | SOCKETS, DIP8 | \$ 3.20000 |
| 1 | RESISTOR, 2000hm_5\% | \$ 0.10000 |
| 1 | RESISTOR, 1000hm_5\% | \$ 0.10000 |
| 1 | RESISTOR, 180kOhm_5\% | \$ 0.10000 |
| 1 | RESISTOR, 5.1kOhm_5\% | \$ 0.10000 |
| 2 | RESISTOR, 510kOhm_5\% | \$ 0.10000 |
| 2 | RESISTOR, 51kOhm_5\% | \$ 0.10000 |
| 2 | CAPACITOR, 22nF | \$ 0.25000 |
| 1 | RESISTOR, 3000hm_5\% | \$ 0.10000 |
|  |  |  |
|  |  | \$80.77250 |

Figure 40: Bill of Materials for DC-DC converter

## 21 Recommendations

After completing this project and learning what to do and some things not to do, some recommendations are going to be made for any future groups working on this or any similar project.

The first recommendation is to consult more with power engineers. These engineers deal with power all day, they will be able to help you a lot and you will be able to make more progress on the project in a shorter amount of time.

The next couple of recommendations have to do with component selection. When picking components, make sure they are capable of handling the expected voltages/currents. Be aware of any offset or inverting properties of the components being chosen and where unused pins should be connected. Use DIP or TO components. These types of components are easy to test on breadboards and on PCBs. When soldering onto the PCB, use as many sockets as possible. In this project a couple of frequency dividers and logic gates were blown. It would have been very tedious and time-consuming to unsolder the chip and solder in a new one. By soldering sockets into the PCB, you are making it as easy to swap out components as if you were working on your breadboard.

Isolation. Learn about the different types of isolation early and start testing them to see how they respond. Isolation is very important in power applications.

These last couple recommendations deal with PCB layout. Make sure all IC's are facing the same direction. If you have four op-amps, and three of them are facing one way, do not turn the fourth on in another direction even if it does make it easier to draw traces. If someone is just putting the components in and not paying attention to the schematic, there is a very real possibility the IC will be put in backwards. Double and even triple check that all traces are correct before sending the PCB to be made. Its one thing to have to add resistors and capacitors to make an IC work, but if you have to cut traces and then physically re-wire the circuit, it is going to take a lot of time. If you are making a large board, have holes drilled in each of the four corners for legs to be inserted to hold it up, depending on size, you might even want a fifth hole drilled near the center of the board where it is more pliable. Although it might make things a bit more visually difficult to understand, make good use of your board space. Spacing components out and grouping them by task may make it easier to visually pick out what is going on, but if an engineer were to see it, he or she might think you don't know what you're doing.

These are all the recommendations that are going to be made. Hopefully it will help future groups make better use of their time and resources.

## 22 Overall Conclusion

Based on the research that was done, there is a need for 12 volt to 170 volt DC-DC converters, especially when being used with sine wave inverters. For the desired power rating of 250 W , a push pull topology seems to work best with an efficiency rating of $85 \%$ at 350 W . Half bridge and full bridge operate at much higher power ratings.

Based on schematics and simulations, the device should have worked, however before the design could even be tested changes were made to ensure it worked. Once testing began, revisions to the board continued with each change that was made, an updated schematic was made as well. This was in case there was time to get a new board printed that had all the corrections on it.

Even with modifications to the design, the board still did not work the first time it was connected to power. More changes were made and now the device works, although not as expected. The MOSFETs are not switching as expected during high current tests. On a slightly more upbeat note, the power lost through the control circuitry is only 360 mW .

Although the board might not work as expected, a lot was learned by both team members in terms of researching existing products, finding components to give desired results, schematic and PCB layout skills, debugging and on-demand circuit re-work skills. These skills and experiences they have gained will be kept in their "ECE toolbox" for later use.

## Works Cited

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Appendix A: Half Bridge



## Appendix B: Full Bridge





## Appendix C: Push Pull




## Appendix D：Value Analysis Chart

|  |  |  |  |  | $\begin{aligned} & \stackrel{\rightharpoonup}{\overline{0}} \\ & \stackrel{y}{3} \\ & 0 . \frac{1}{0} \\ & \stackrel{\rightharpoonup}{0} \end{aligned}$ |  |  | $\begin{aligned} & \text { त্ত } \\ & \frac{0}{0} \\ & \frac{1}{0} \\ & \frac{1}{0} \\ & 0 \\ & 0 \end{aligned}$ | $$ |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Weighting | 85 | 70 | 100 | 10 | 50 | 30 | 60 | 35 | RS | WS |
| Buck－ Boost |  |  | 4 |  | 4 | 5 |  |  | 13 | 750 |
| Forward | 3 | 0 | 3 | 5 |  | 4 | 1 |  | 16 | 785 |
| Flyback | 2 | 0 | 2 | 5 | 2 | 4 | 0 |  | 15 | 640 |
| Half－ Bridge | 2 | 1 | 4 | 1 |  | 2 | 2 | 1 | 13 | 865 |
| Full－Bridge | 2 | 1 | 4 | 1 |  | 1 | 4 | 2 | 15 | 990 |
| Push－Pull | 3 | 1 | 3 | 2 | 0 | 2 | 4 |  | 15 | 945 |
| Zero <br> Voltage |  |  | 3 |  |  |  | 4 |  | 7 | 540 |

# High Voltage DC-DC Converter <br> Nelson <br> Ruscitti 

## Appendix E: Bill of Materials

| Quantity | Description | RefDes | Package Vendor | Status | Price | Vendor Part | Manufacture | \anufacture |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 2 | RESISTOR, 1.0kOh | R2, R1 | Generic\RE¢ECE Shop |  | \$ 0.10000 |  |  |  |
| 2 | CAPACITOR, 5.1nF | C3, C1 | Generic\CAF Digikey |  | \$ 0.47200 | 445-2429-NL | TDK Corpor | CS17-F2GA |
| 1 | CAPACITOR, 1.0uF | C2 | Generic\CAF ECE Shop |  | \$ 0.25000 |  |  |  |
| 2 | ZENER, 02BZ2.2 | D4, D3 | Generic\DO-35 |  | \$ 0.99000 |  | ST Microele | STTH5L06R |
| 2 | POWER_MOS_N, II | Q2, Q1 | Generic\TO-220AB |  | \$13.00000 |  | ST Microele | Y140NS10 |
| 1 | Transformer |  | Magnetics |  | \$39.76000 |  |  |  |
| 1 | INDUCTOR, 10mH | L1 | Generic\IND5 |  | \$ 9.56000 |  | JW Miller A | 1140-103K- |
| 2 | DIODE, 1N4151 | D2, D1 | Generic\DO-35 |  | \$ 0.01050 |  | Fairchild Se | 1N4151 |
| 1 | 50_AMP, 50_AMP | F1 | Generic\FUSECE Shop |  | \$ 0.25000 |  |  |  |
| 1 | Banana Jack | 12V input1 | Digikey |  | \$ 7.93000 |  | Pomona Ele | MDP-02 |
| 1 | RESISTOR, 1.0kOh | R5 | Generic\RE§ECE Shop |  | \$ 0.10000 |  |  |  |
| 1 | RESISTOR, 10kOhn | R7 | Generic\RESECE Shop |  | \$ 0.10000 |  |  |  |
| 5 | RESISTOR, 20kOhn | R8, R11, R14, | Generic\RE¢ECE Shop |  | \$ 0.10000 |  |  |  |
| 1 | CAPACITOR, 1.0nF | C2 | GenericlCAF ECE Shop |  | \$ 0.25000 |  |  |  |
| 1 | CAPACITOR, 10nF | C3 | Generic\CAF ECE Shop |  | \$ 0.25000 |  |  |  |
| 2 | CAP_ELECTROLIT, | C4, C6 | Generic\ELK ECE Shop |  | \$ 1.00000 |  |  |  |
| 1 | RESISTOR, 7.5kOh | R6 | Generic\RESECE Shop |  | \$ 0.10000 |  |  |  |
| 2 | RESISTOR, 200kOr | R10, R13 | Generic\RE¢ECE Shop |  | \$ 0.10000 |  |  |  |
| 1 | VOLTAGE_REGULA | U6 | Generic\TO- ECE Shop |  | \$ 0.60000 |  | ST Microele | 7805CV |
| 4 | OPAMP, TL082CP | U3, U8, U4, U5 | Generic\PDI ECE Shop |  | \$ 0.64000 |  | Texas Instrı | TL082CP |
| 2 | 74LS, 74LS08D | AND_Gate1_A, | Generic\DO: ECE Shop |  | \$ 0.53000 |  | Fairchild Se | 74LS08 |
| 1 | 74STD, 7474N | flip_flop | Generic\NO: ECE Shop |  | \$ 0.53000 |  | Texas Instrı | 7474N |
| 2 | SOCKETS, DIP8 | Driver1, Driver | Generic\DIP-8 |  | \$ 3.20000 |  | National Se | LM5104 |
| 1 | RESISTOR, 2000hn | R17 | Generic\RE§ECE Shop |  | \$ 0.10000 |  |  |  |
| 1 | RESISTOR, 1000hn | R19 | Generic\RE§ECE Shop |  | \$ 0.10000 |  |  |  |
| 1 | RESISTOR, 180 kOr | R4 | Generic\RESECE Shop |  | \$ 0.10000 |  |  |  |
| 1 | RESISTOR, 5.1 kOh | R9 | Generic\RESECE Shop |  | \$ 0.10000 |  |  |  |
| 2 | RESISTOR, 510kOr | R2, R12 | Generic\RE§ECE Shop |  | \$ 0.10000 |  |  |  |
| 2 | RESISTOR, 51kOhn | R1, R3 | Generic\RESECE Shop |  | \$ 0.10000 |  |  |  |
| 2 | CAPACITOR, 22nF | C1, C5 | GenericlCAF ECE Shop |  | \$ 0.25000 |  |  |  |
| 1 | RESISTOR, 3000hn | R18 | Generic\RE§ECE Shop |  | \$ 0.10000 |  |  |  |

## Appendix F: Transformer Spec Sheet



[^6]

## Appendix G: MOSFET Spec Sheet

| $\Sigma_{7}$ | STY140NS10 |
| :---: | :---: |
|  | N-CHANNEL $100 \mathrm{~V}-0.009 \Omega-140 \mathrm{~A}$ MAX247 ${ }^{\text {™ }}$ |
|  | MESH OVERLAY ${ }^{\text {™ }}$ POWER MOSFET |


| TYPE | $\mathrm{V}_{\text {Dss }}$ | $\mathrm{R}_{\mathrm{Ds} \text { (on) }}$ | $\mathrm{I}_{\mathrm{D}}$ |
| :---: | :---: | :---: | :---: |
| STY140NS10 | 100 V | $40.011 \Omega$ | 140 A |

- TYPICAL RDs(on) $=0.009 \Omega$
- STANDARD THRESHOLD DRIVE
- $100 \%$ AVALANCHE TESTED

DESCRIPTION
Using the latest high voltage MESH OVERLAYTu process, STMicroelectronics has designed an advanced family of power MOSFETs with outstanding performances. The new patent pending strip layout coupled with the Company's proprietary edge termination structure, gives the lowest RDS(on) per area, exceptional avalanche and dvidt capabities and unrivalled gate charge and switching characteristics.


INTERNAL SCHEMATIC DIAGRAM

## APPLICATIONS

- HIGH CURRENT. HIGH SWITCHING SPEED
- SWITCH MODE POWER SUPPLY (SMPS)



## ABSOLUTE MAXIMUM RATINGS

| Symbol | Parameter | Value | Unit |
| :---: | :---: | :---: | :---: |
| VDS | Drain-source Voltage ( $\mathrm{V}_{\text {GS }}=0$ ) | 100 | V |
| VIGR | Drain-gate Voltage ( $\mathrm{RGS}_{9}=20 \mathrm{kS}$ ) | 100 | V |
| $V_{\text {GS }}$ | Gate-source Voltage | $\pm 20$ | V |
| To | Drain Current (continuos) at $T_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | 140 | A |
| T | Drain Current (continuos) at $T_{\mathrm{C}}=100^{\circ} \mathrm{C}$ | 99 | A |
| lom(*) | Drain Current (pulsed) | 560 | A |
| Ptot | Total Dissipation at $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | 450 | W |
|  | Derating Factor | 3 | W/ ${ }^{\circ} \mathrm{C}$ |
| EAS(1) | Single Pulse Avalanche Energy | 2900 | mJ |
| dwdt( 2 ) | Peak Diode Recovery voliage slope | 5 | V/ns |
| Tsto | Storage Temperature | -55 to 175 | ${ }^{\circ} \mathrm{C}$ |
| T] | Operating Junction Temperature | -55 to 175 | ${ }^{\circ} \mathrm{C}$ |

(*) Pulse widith Imited by sate operating area.
(1) Btarting $T /=25^{\circ} \mathrm{C}$, $1 \mathrm{D}=70 \mathrm{~A}$, VDO -50 V

August 2001

## Appendix H: Driver Spec Sheet



## Appendix I: Filter Inductor Spec Sheet

High Current Chokes

## Special Features

- Very ligh current capacity

LOW OCR

- Epoxy coated fenite bobbn core
- VW - 1 rated strirk tubing to cover vinding
- Self-laaded
- Frxed lead spacing
- Center hole for mechankal mounting
- Drelectuk withstanding voltage:

2500 vims terminal to shrirk tute cover: 1000 vrms terminal to core

- Operating temperature -55 to $+105^{\circ} \mathrm{C}$


## Notes

- Rated current to cause $50^{\circ} \mathrm{C}$ max temperature nise and $5 \%$ max. inductance drop



## Appendix J: Flip-Flop Spec Sheet

|  |  |  |
| :---: | :---: | :---: |
| Package Options Include Plastic Small-Outline (D) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) $300-\mathrm{mll}$ DIPs |  |  |
| TYPE | TYPICAL MAXIMUM CLOCK FREQUENCY $\begin{gathered} \left(C_{L}=60 \mathrm{pF}\right) \\ (\mathrm{M}-\mathrm{z}) \end{gathered}$ | TYPICAL POWER DISAPATION PER FUIPFLOP (mW) |
| NLS74A | 50 | 6 |
| N374A | 134 | 25 |

description
These devices contaln two independent positive-edge-triggered D-type flp-flops. A low level at the preset(PRE) or clear (CLR) inputs sets or resets the outputs regardless of the levels of the other Inputs. When $\overline{\text { PRE }}$ and $\overline{C L R}$ are Inactive (high), data at the data (D) Input meeting the setup-time requirements are transferred to the outputs on the positive-going edge of the clock (CLK) pulse. Clock triggering occurs at a voltage level and is not directiy related to the rise time of CLK. Following the hold-time interval, data at the D input can be changed without afecting the levels at the outputs.

The SN54ALS74A and SN54AS74A are characterized for operation over the full milltary temperature range of $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$. The SN74ALS74A and SN74AS74A are characterized for operation from $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$.

FUNCTION TABLE

| INPUT8 |  |  |  | OUTPUT2 |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\overline{\text { PRE }}$ | CLR | CUK | D | Q | $\bar{Q}$ |
| L | H | X | X | H | L |
| H | L | X | X | L | H |
| L | L | X | X | HT | Ht |
| H | H | T | H | H | L |
| H | H | T | L | L | H |
| H | H | L | X | OO $_{0}$ | $\bar{Q}_{0}$ |

The output levels in inis conflgurstion are not specined tomeet the minimumievelsfor $\mathrm{V}_{\mathrm{CH}}{ }^{\text {If }}$ the lows at FRE and CLR are near VIL madmum. Furthemore, tis compuration is norstable; that is, It does not perslat when PFE or CLR rehms to is inactive (iligh) leve.

## Appendix K: NAND Gate Spec Sheet HD74LS00 ©ousdruvise 2 -ineut Postive NaNo Gates


mPIN ARRANGEMENT


■ELECTRICAL CHARACTERISTICS ( $T a=-20 \sim+75^{\circ} \mathrm{C}$ )

| Itee | Symbol | Test Condicions |  | min | trp ${ }^{*}$ | max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Ingut roltage | $V_{r a}$ |  |  | 2.0 | - | - | V |
|  | Vr |  |  | - | - | 0.8 | V |
| Output soltage | Vne | $V_{C c}=4.75 \mathrm{~V}, V_{l 2}=0.8 \mathrm{~V}, \mathrm{Las}=-400 \mathrm{mt}$ |  | 2.7 | - | - | V |
|  | $V_{1}$ | $V_{c c}=4.75 \mathrm{~V}, V_{w}=2 \mathrm{~V}$ | $b \mathrm{c}=3 \mathrm{ma}$ | - | - | 0.5 | V |
|  |  |  | $50 \mathrm{c}=4 \mathrm{~m} A$ | - | - | 0.4 |  |
| Bput curreas | IIIT | $V_{c c}=5.25 \mathrm{~V}, \quad V_{l}=2.7 \mathrm{~V}$ |  | - | - | + 20 | $\mu \mathrm{A}$ |
|  | IL | $V_{c c}=5.25 \mathrm{~V}, \quad V_{t}=0.4 \mathrm{~V}$ |  | - | - | -0.4 | nA |
|  | 4 | $\mathrm{Vcs}_{\text {c }}=5 . \Sigma \mathrm{zV}, \quad \mathrm{V}_{\mathrm{c}}=7 \mathrm{~V}$ |  | -- | - | 0.1 | mA |
| Shert-tircuit oatput curreat | 508 | $V_{\text {cc }}=5.25 \mathrm{~V}$ |  | -20 | - | -100 | mA |
| Supply current | Sces | $\mathrm{Vcc}=5.8 \mathrm{SY}$ |  | - | 0.8 | 1.6 | mi |
|  | kes | $V C c=5.25 \mathrm{~V}$ |  | - | 2.4 | 4.4 | mA |
| Input elamp soltage | Vir | $V_{c c}=4.75 \mathrm{~V}, 4 \mathrm{Lx}=-18 \mathrm{nA}$ |  | - | - | $-1.5$ | V |

- $V_{C c}-5 \mathrm{~V}, T \mathrm{a}=25^{*} \mathrm{C}$

SWITCHING CHARACTERISTICS ( $V c c=5 \mathrm{~V}, T_{a}=25^{\circ} \mathrm{C}$ )

| Item | Symbol | Test Conditions | min | typ | mex | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Propagation delay time | BPLa | $\mathrm{CL}_{\mathrm{L}}=15 \mathrm{pF}, \quad \mathrm{R}_{2}=2 \mathrm{k} \mathrm{l}$ | - | 9 | 15 | 38 |
|  | tras |  | - | 10 | 15 | $\pm$ |

Nasa) Refer to Teat Crevit and Wewtorm of the Common item

## Appendix L: Rectifier Diode Spec Sheet

$\overline{\boldsymbol{Y y}} \quad$ STTH5L06

TURBO 2 ULTRAFAST HIGH VOLTAGE RECTIFIER

MAIN PRODUCT CHARACTERISTICS

| Iflay | 5 A |
| :---: | :---: |
| Vren | 600 V |
| In (max) | $150 \mu \mathrm{~A}$ |
| T] ( $\max$ ) | $175{ }^{\circ} \mathrm{C}$ |
| $V_{F}($ max $)$ | 1.05 V |
| trr (max) | 95 ns |

FEATURES AND BENEFITS

- Uliralast switching
- Low reverse recovery current
- Reduces switching \& conduction lobses
- Low thermal resistance


## DESCRIPTION



The STTH5LO5, which is using ST Turto 2600 V technology, is specially sulted as boost diode in discontinuous or critical mode power factor corrections.
The device is also intended for use as a free wheeling dlode in power supplles and other power switching applications.

ABSOLUTE RATINGS (IImling values)

| Symbol | Parameter |  | Value | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Vrfon | Repetitive peak reverse voltage |  | 600 | V |
| Ifprus) | RMS forward current |  | 20 | A |
| lfatal | Average forward current | $\mathrm{Tl}=50^{\circ} \mathrm{C} \quad \delta=0.5$ | 5 | A |
| Ifsan | Surge non repettive forward current | tp $=10 \mathrm{~ms}$ Sinusoidal | 110 | A |
| $T_{\text {sp }}$ | Storage temperature range |  | $-65+175$ | ${ }^{\circ} \mathrm{C}$ |
| T] | Maximum operating Junction temperature |  | +175 | ${ }^{\circ} \mathrm{C}$ |

## Appendix M: Opamp Spec Sheet

WIDE COMMMON-MODE (UP TO VCC') AND
DIFFERENTIAL VOLTAGE RANGE
LOW INPUT BIAS AND OFFSET CURRENT
OUTPUT SHORT-CIRCUIT FROTECTION
HIGH INPUT IMPEDANCE J-FET INPUT
STAGE
INTERNAL FREGUENCY COMPENSATION
LATCH UP FREE OPERATION
HIGH SLEW RATE : $16 V / \mu S ~(t y P) ~$

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    WIDE COMMON-MODE (UP TO VCC') AND DIFFERENTIAL VOLTAGE RANGE
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## DESCRIPTION

The TLO32, TL082A and TL0325 are high speed J-FET Input dual operational ampiners incorporating well maxhed, high voltage J-FET and blpolar transistors in a monoitthic integrated circult.

The devlces feature high slew rates, low input das and offse: current, and low offset voltage temperature coefinclent


ORDER CODE

| Part Number | Temperature Rango | Faokage |  |  |
| :---: | :---: | :---: | :---: | :---: |
|  |  | N | D | P |
| TLCA2MIAWEM | $-55^{\circ} \mathrm{C},-125^{\circ} \mathrm{C}$ | * | - | * |
| TLCA2I/Al/E: | $-40^{\circ} \mathrm{C},-105^{\circ} \mathrm{C}$ | * | * | * |
| TLCA2CIACIBC | $0^{\circ} \mathrm{C}, 7 \mathrm{C}^{\circ} \mathrm{C}$ | - | * | * |
| Example : TLOB2CD, TLC82IN |  |  |  |  |

$\mathrm{H}=$ Deal in Lin Farcese (DP)

 4 IVoel (FT)

PIN CONNECTIONS (top vew)


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[^0]:    ${ }^{1} \mathrm{http}: / / \mathrm{www} . h i l l \mathrm{~s} 2 . \mathrm{u}-$ net.com/electron/smps.htm

[^1]:    ${ }^{2} \mathrm{http}: / / \mathrm{www} . h i l l \mathrm{~s} 2 . \mathrm{u}-$ net.com/electron/smps.htm

[^2]:    ${ }^{3} \mathrm{http}: / / \mathrm{www} . \mathrm{hills} 2 . \mathrm{u}-$ net.com/electron/smps.htm

[^3]:    ${ }^{4} \mathrm{http}: / / \mathrm{www} . h i l l s 2 . \mathrm{u}-$ net.com/electron/smps.htm

[^4]:    ${ }^{5} \mathrm{http}: / / \mathrm{www} . h i l l$ s2.u-net.com/electron/smps.htm
    ${ }^{6} \mathrm{http}$ ://www.hills2.u-net.com/electron/smps.htm

[^5]:    ${ }^{7}$ Emanual, Alexander.

[^6]:    *These values are only applicable for M.PP Cores.

